L Number	Hits	Search Text	DB	Time stamp
25	79	((((((438/626) or (438/627) or (438/631) or (438/633) or (438/635) or (438/643) or (438/653) or (438/653) or (438/672) or (438/687) or (438/692) or (438/700) or (438/702) or (438/958)).CCLS.) and copper and ((copper adj oxide) or "CuO.sub.2" or CuO)) and (cmp or (chemical\$2 adj mechanical\$2 adj polish\$3)) and barrier) and interconnect\$3) and (ammonia or "NH.sub.3") and (nitrogen or "N.sub.2")	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/05 16:47
26	6	and plasma ((((((((438/626) or (438/627) or (438/631) or (438/633) or (438/635) or (438/643) or (438/653) or (438/653) or (438/667) or (438/692) or (438/672) or (438/702) or (438/958)).CCLS.) and copper and ((copper adj oxide) or "CuO.sub.2" or CuO)) and (cmp or (chemical\$2 adj mechanical\$2 adj polish\$3)) and barrier) and interconnect\$3) and (ammonia or "NH.sub.3") and (nitrogen or "N.sub.2") and plasma) and (flow near5 rate) and (cap\$4 near5 thickness)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/05
27	2	(("6255217") or ("6211085")).PN.	USPAT	2004/08/05 17:01
-	8116	((438/626) or (438/627) or (438/631) or (438/633) or (438/635) or (438/643) or (438/653) or (438/653) or (438/672) or (438/687) or (438/692) or (438/700) or (438/702) or (438/958)).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/04
-	404	(((438/626) or (438/627) or (438/631) or (438/633) or (438/635) or (438/643) or (438/653) or (438/653) or (438/672) or (438/687) or (438/692) or (438/700) or (438/702) or (438/958)).CCLS.) and copper and ((copper adj oxide) or "CuO.sub.2" or CuO)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/04 19:58
-	307	((((438/626) or (438/627) or (438/631) or (438/633) or (438/635) or (438/643) or (438/653) or (438/653) or (438/672) or (438/687) or (438/692) or (438/700) or (438/702) or (438/958)).CCLS.) and copper and ((copper adj oxide) or "CuO.sub.2" or CuO)) and (cmp or (chemical\$2 adj mechanical\$2 adj polish\$3)) and barrier	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/04
_	260	(((((438/626) or (438/627) or (438/631) or (438/633) or (438/635) or (438/643) or (438/653) or (438/672) or (438/687) or (438/692) or (438/700) or (438/702) or (438/958)).CCLS.) and copper and ((copper adj oxide) or "CuO.sub.2" or CuO)) and (cmp or (chemical\$2 adj mechanical\$2 adj polish\$3)) and barrier) and interconnect\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/04 20:00
_	79	Interconnect\$3 (((((438/626) or (438/627) or (438/631) or (438/633) or (438/635) or (438/643) or (438/653) or (438/653) or (438/653) or (438/672) or (438/692) or (438/700) or (438/702) or (438/958)).CCLS.) and copper and ((copper adj oxide) or "CuO.sub.2" or CuO)) and (cmp or (chemical\$2 adj mechanical\$2 adj polish\$3)) and barrier) and interconnect\$3) and (ammonia or "NH.sub.3") and (nitrogen or "N.sub.2") and plasma	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/05 16:46